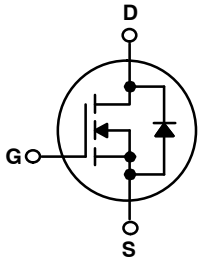
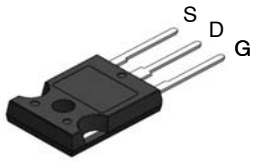
MOSFET – N-Channel, SUPERFET II, FRFET®

650 V, 24 A, 150 mΩ

FCH150N65F

V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
650 V	150 mΩ @ 10 V	24 A





TO−247−3LD
CASE 340CH

Description

SUPERFET® II MOSFET is **onsemi**'s brand−new high voltage super−junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on−resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SUPERFET II FRFET® MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

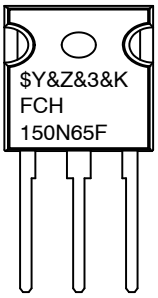
Features

- 700 V @ T_J = 150°C
- Typ. $R_{DS(on))}$ = 133 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 72 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 361 pF)
- 100% Avalanche Tested
- This Device is Pb−Free and is RoHS Compliant

Applications

- LCD, LED, PDP TV
- Solar Inverter
- Telecom, Server Power Supplies
- AC−DC Power Supply

MARKING DIAGRAM



$Y	= **onsemi** Logo
&Z	= Assembly Plant Code
&3	= Numeric Date Code
&K	= Lot Code
FCH150N65F	= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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ABSOLUTE MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Symbol	Parameter		FCH150N65F−F155	Unit
V_{DSS}	Drain to Source Voltage		650	V
V_{GSS}	Gate to Source Voltage	−DC	±20	V
		−AC (f > 1 Hz)	±30	
I_D	Drain Current	−Continuous (T_C = 25°C)	24	A
		−Continuous (T_C = 100°C)	14.9	
I_{DM}	Drain Current	−Pulsed (Note 1)	72	A
E_{AS}	Single Pulsed Avalanche Energy (Note 2)		663	mJ
I_{AR}	Avalanche Current (Note 1)		4.7	A
E_{AR}	Repetitive Avalanche Energy (Note 1)		2.98	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
P_D	Power Dissipation	(T_C = 25°C)	298	W
		−Derate Above 25°C	2.38	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		−55 to + 150	°C
T_L	Maximum Lead Temperature for Soldering, ⅛ from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. I_{AS} = 4.7 A, R_G = 25 Ω, Starting T_J = 25°C
3. I_{SD} ≤ 12 A, di/dt ≤ 200 A/μs, V_{DD} ≤ 380 V, Starting T_J = 25 °C.

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCH150N65F−F155	FCH150N65F	TO−247−3LD	Tube	N/A	N/A	30 Units

THERMAL CHARACTERISTICS

Symbol	Parameter	FCH150N65F−F155	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.42	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

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ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
OFF CHARACTERISTICS						
BV_{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 10 mA, T_J = 25°C	650	–	–	V
		V_{GS} = 0 V, I_D = 10 mA, T_J = 150°C	700	–	–	
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, Referenced to 25°C	–	0.72	–	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 650 V, V_{GS} = 0 V	–	–	10	μA
		V_{DS} = 520 V, V_{GS} = 0 V, T_C = 125°C	–	86	–	
I_{GSS}	Gate to Body Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V	–	–	±100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate Threshold Voltage	V_{GS} = V_{DS}, I_D = 2.4 mA	3	–	5	V
$R_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 12 A	–	133	150	mΩ
g_{FS}	Forward Transconductance	V_{DS} = 20 V, I_D = 12 A	–	22	–	S
DYNAMIC CHARACTERISTICS						
C_{iss}	Input Capacitance	V_{DS} = 100 V, V_{GS} = 0 V, f = 1 MHz	–	2810	3737	pF
C_{oss}	Output Capacitance		–	91	121	pF
C_{rss}	Reverse Transfer Capacitance		–	0.77	–	pF
C_{oss}	Output Capacitance	V_{DS} = 380 V, V_{GS} = 0 V, f = 1 MHz	–	54	–	pF
$C_{oss(eff.)}$	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V	–	361	–	pF
$Q_{g(tot)}$	Total Gate Charge at 10 V	V_{DD} = 380 V, I_D = 12 A, V_{GS} = 10 V (Note 4)	–	72	94	nC
Q_{gs}	Gate to Source Gate Charge		–	15	–	nC
Q_{gd}	Gate to Drain “Miller”Charge		–	31	–	nC
ESR	Equivalent Series Resistance	f = 1 MHz	–	0.69	–	Ω
SWITCHING CHARACTERISTICS						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 380 V, I_D = 12 A, V_{GS} = 10 V, R_G = 4.7 Ω (Note 4)	–	28	66	ns
t_r	Turn-On Rise Time		–	15	40	ns
$t_{d(off)}$	Turn-Off Delay Time		–	73	156	ns
t_f	Turn-Off Fall Time		–	6	22	ns
DRAIN-SOURCE DIODE CHARACTERISTICS						
I_S	Maximum Continuous Drain to Source Diode Forward Current		–	–	24	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		–	–	72	A
V_{SD}	Drain to Source Diode Forward Voltage	V_{GS} = 0 V, I_{SD} = 12 A	–	–	1.2	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_{SD} = 12 A, dI_F/dt = 100 A/μs	–	123	–	ns
Q_{rr}	Reverse Recovery Charge		–	597	–	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

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TYPICAL PERFORMANCE CHARACTERISTICS

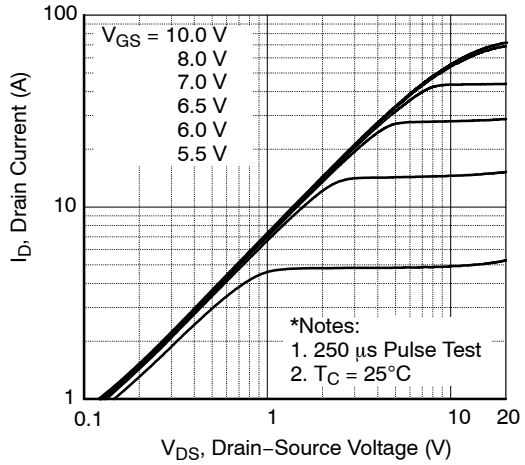

Figure 1. On−Region Characteristics

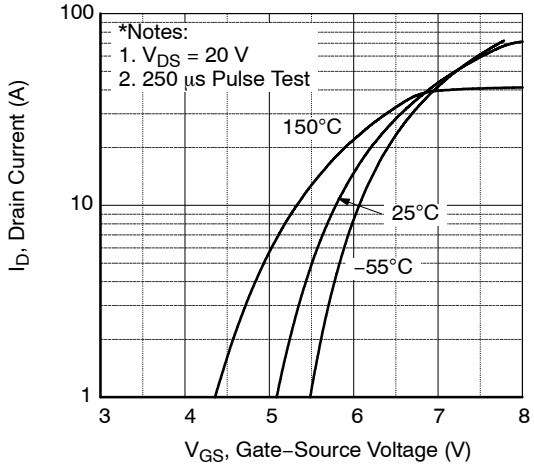

Figure 2. Transfer Characteristics

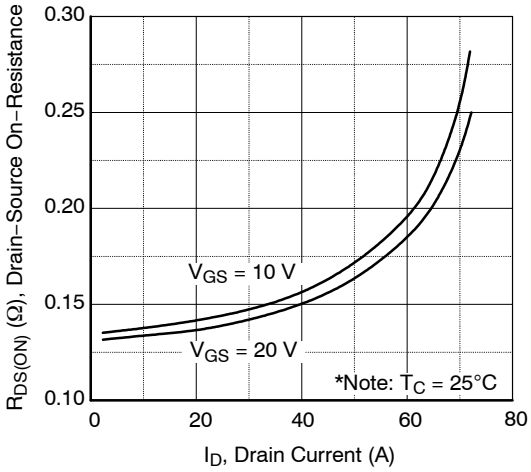

Figure 3. On−Resistance Variation vs. Drain Current and Gate Voltage

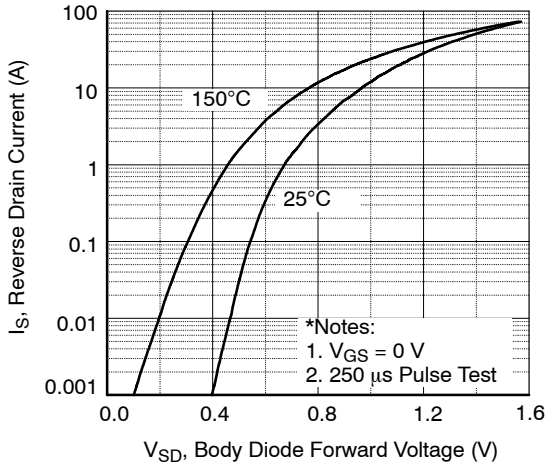

Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

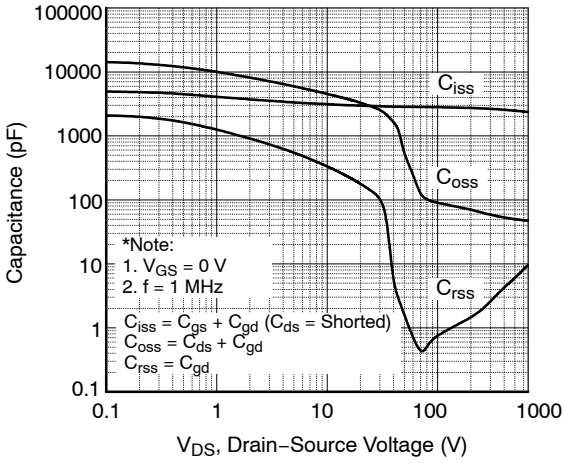

Figure 5. Capacitance Characteristics

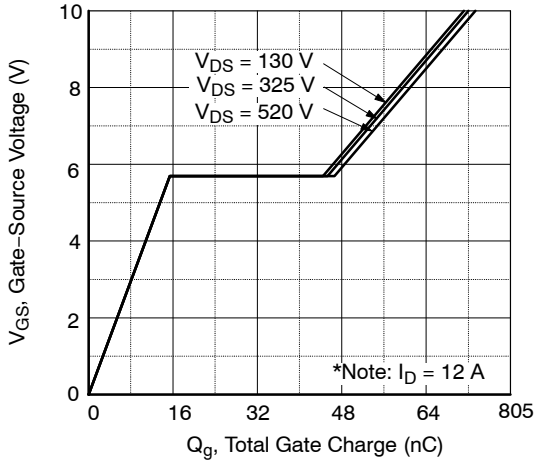

Figure 6. Gate Charge Characteristics

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TYPICAL PREFORMANCE CHARACTERISTICS (CONTINUED)

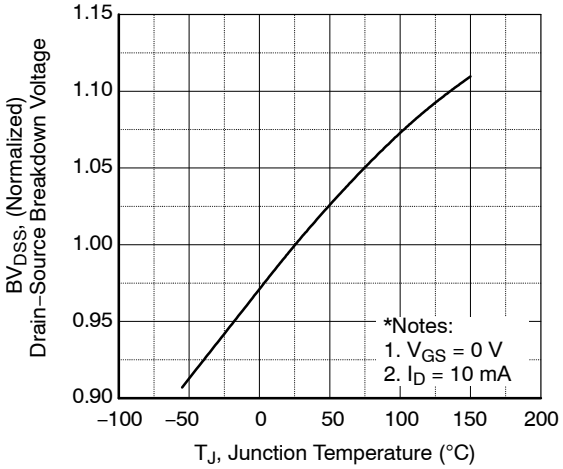

Figure 7. Breakdown Voltage Variation vs. Temperature

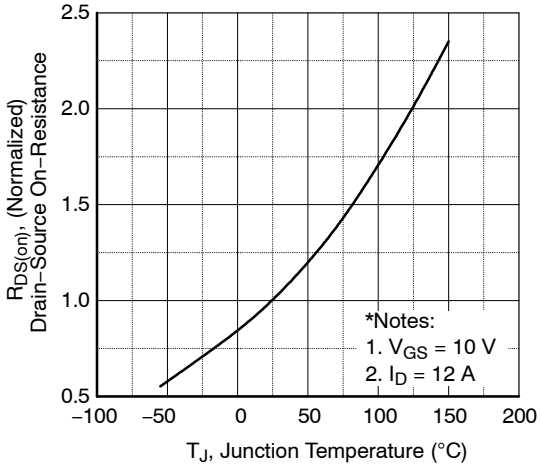

Figure 8. On−Resistance Variation vs. Temperature

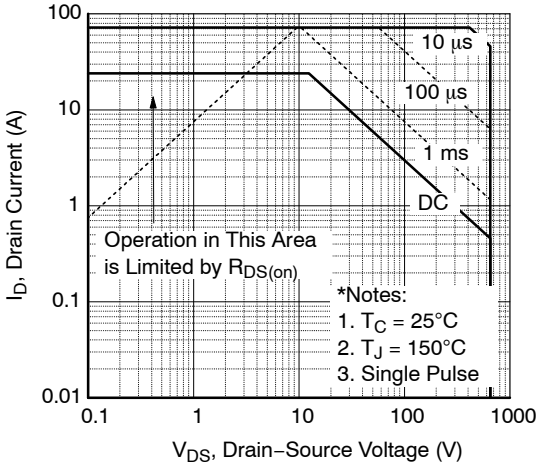

Figure 9. Maximum Safe Operating Area

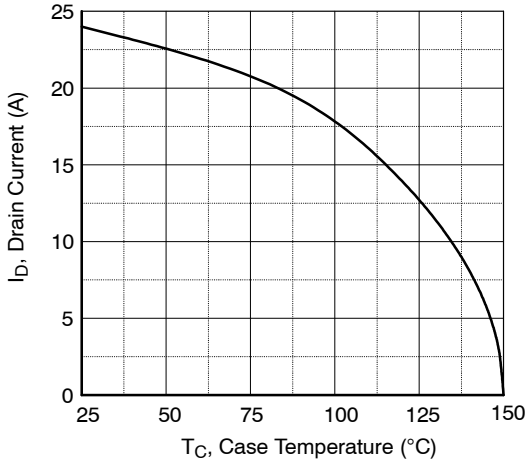

Figure 10. Maximum Drain Current vs. Case Temperature

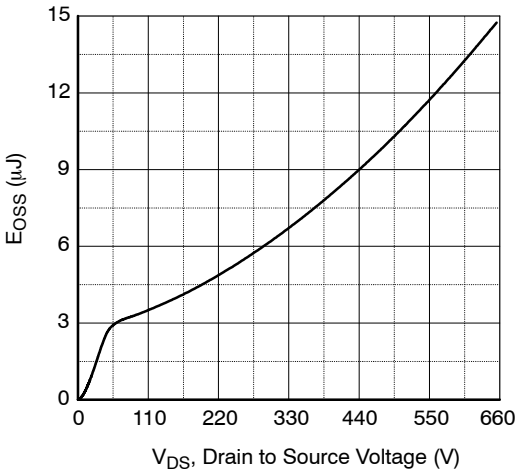

Figure 11. E_{OSS} vs. Drain to Source Voltage

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TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

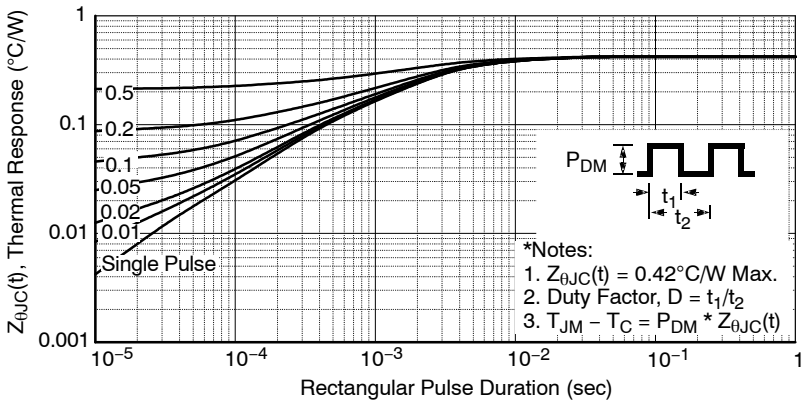

Figure 12. Transient Thermal Response Curve

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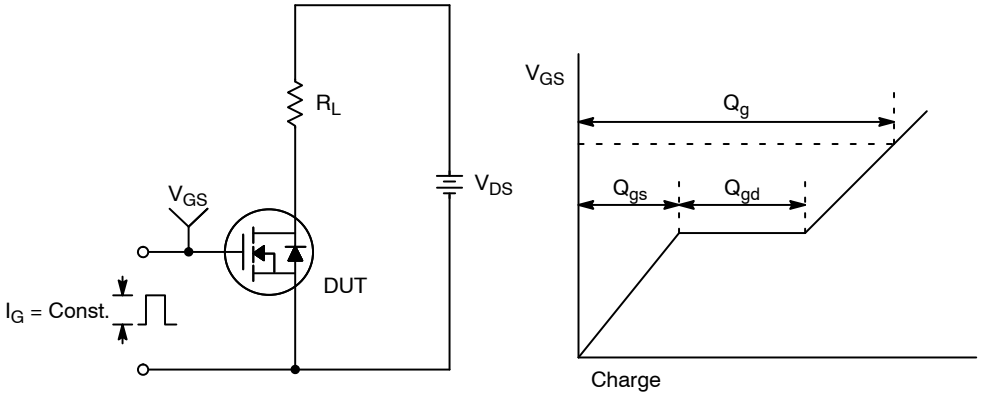

Figure 13. Transient Thermal Response Curve

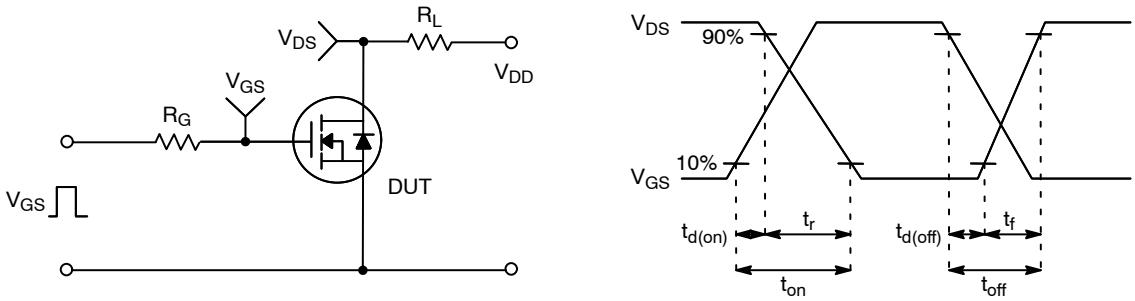

Figure 14. Resistive Switching Test Circuit & Waveforms

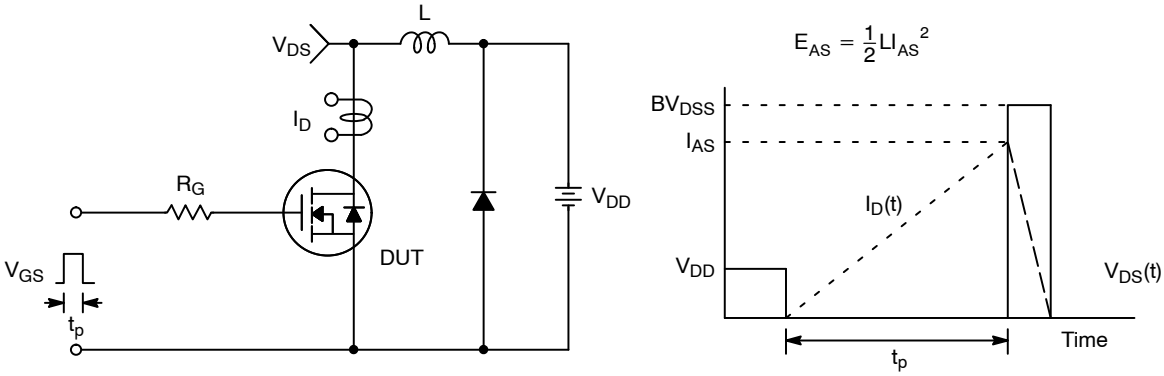

Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

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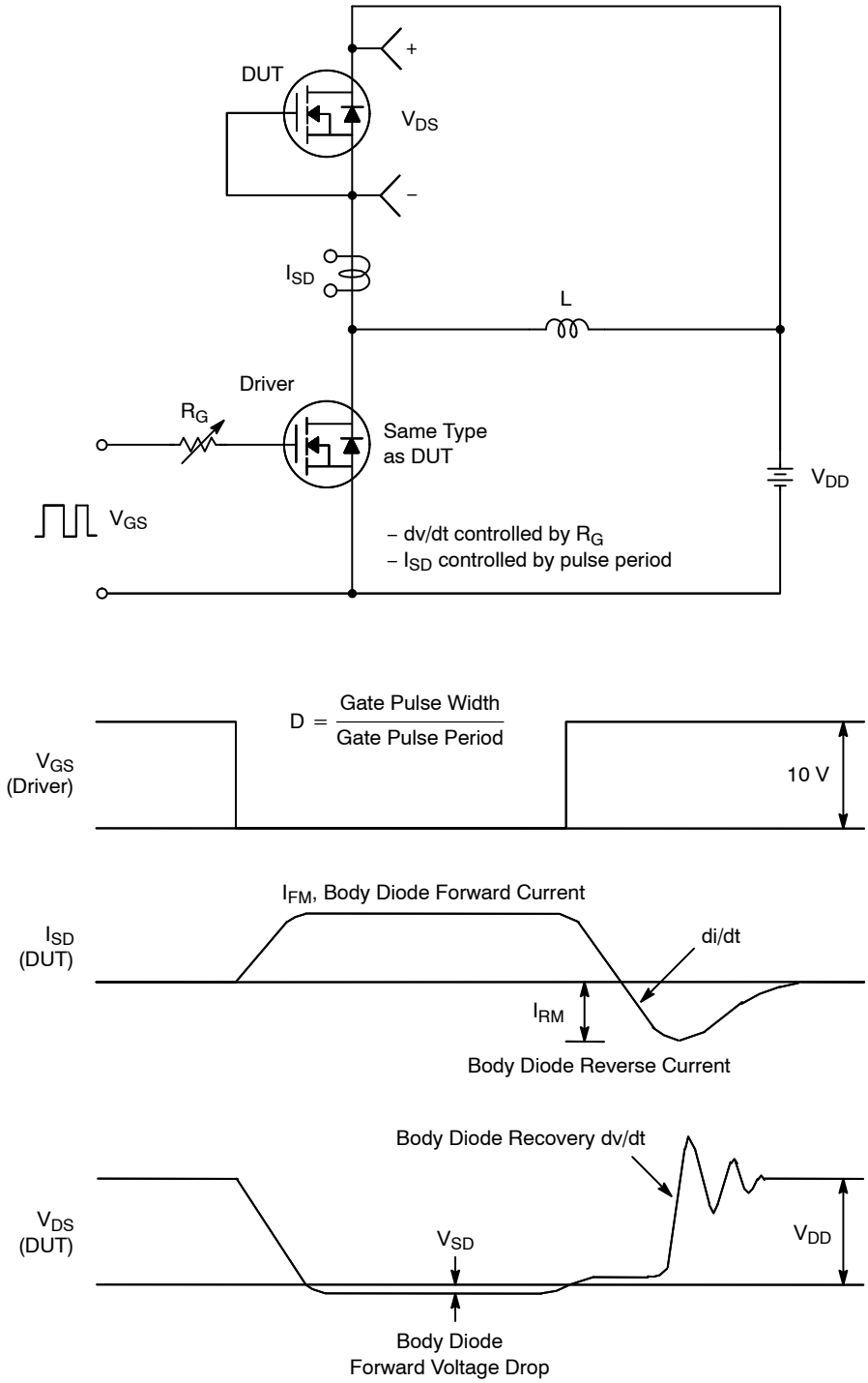

Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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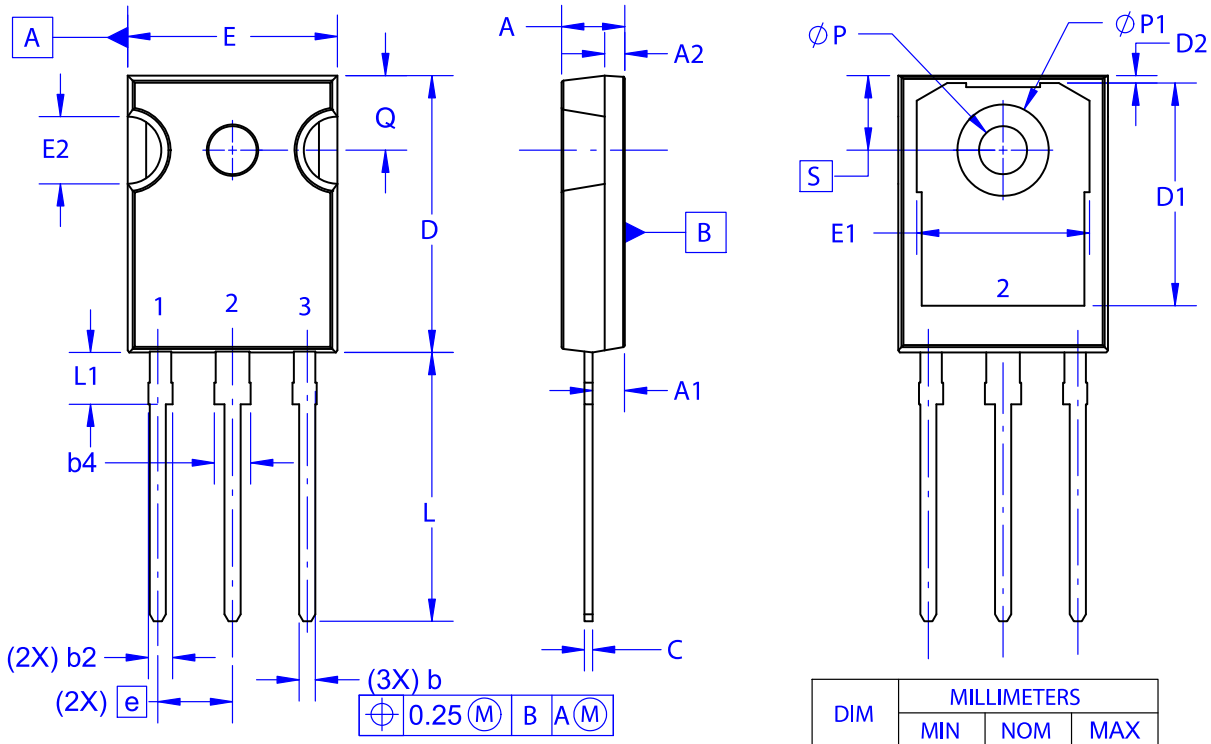
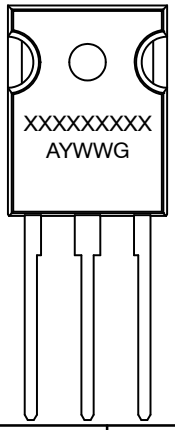


NOTES: UNLESS OTHERWISE SPECIFIED.

A. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.58	4.70	4.82
A1	2.29	2.475	2.66
A2	1.40	1.50	1.60
D	20.32	20.57	20.82
E	15.37	15.62	15.87
E2	4.96	5.08	5.20
e	~	5.56	~
L	19.75	20.00	20.25
L1	3.69	3.81	3.93
ØP	3.51	3.58	3.65
Q	5.34	5.46	5.58
S	5.34	5.46	5.58
b	1.17	1.26	1.35
b2	1.53	1.65	1.77
b4	2.42	2.54	2.66
c	0.51	0.61	0.71
D1	13.08	~	~
D2	0.51	0.93	1.35
E1	12.81	~	~
ØP1	6.61	6.73	6.85

GENERIC
MARKING DIAGRAM*



XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

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